Mullite 3D Printed Humidity Sensors

Yurii Milovanov 1,2, Arianna Bertero 1, Bartolomeo Coppola 1, Paola Palmero 1 and Jean-Marc Tulliani 1,*

1 INSTM R.U PoliTO-LINCE Laboratory, Department of Applied Science and Technology, Politecnico di Torino, Corso Duca degli Abruzzi 24, 10129 Turin, Italy; yurii.milovanov@polito.it or juri_milovanov@yahoo.com (Y.M.); arianna.bertero@polito.it (A.B.); bartolomeo.coppola@polito.it (B.C.); paola.palmero@polito.it (P.P.)
2 Institute of High Technologies, Taras Shevchenko National University of Kyiv, Volodymyrska Street 64, 01601 Kyiv, Ukraine
* Correspondence: jeanmarc.tulliani@polito.it; Tel.: +39-0110904700

Abstract: Mullite substrates with two different porosities were 3D printed, and tested as humidity sensors. To evaluate the effects of porosity on humidity sensitivity, the samples were sintered at 1400 °C (Sensor 1) and 1450 °C (Sensor 2). The sensors were tested in a range from 0% to 85% relative humidity (RH) at room temperature. When exposed to water vapor at room temperature, the impedance value dropped down from 155 MΩ under dry air to 480 kΩ under 85 RH% for Sensor 1 and from 115 MΩ under dry air to 410 kΩ for Sensor 2. In addition, response time and recovery time were below 2 min, whatever the firing temperature, when RH changed from 0% to 74%. Finally, tests carried out involving ammonia, methane, carbon dioxide and nitrogenous oxide, as well as ethanol and acetone, showed no interference.

Keywords: mullite; stereolithography; humidity sensor

1. Introduction

Over the last few decades, the use of humidity sensors to measure and control relative humidity (RH) has attracted significant interest in many industrial sectors, such as automation, food processing (e.g., microwave ovens), agriculture, health care (e.g., drug preparation, medical equipment, and air conditioners) and manufacturing (e.g., electronics and paper manufacturing) [1–4]. In addition, the need for humidity sensors able to operate in extreme conditions (high temperatures and corrosive atmospheres) is also constantly increasing. Thus, there is still an interest in studying humidity sensors today. These sensors can be classified as capacitive, resistive, and thermal conductive [5]. Their operating principle is based on the adsorption of water molecules, which changes the electrical properties, such as the capacitance or resistance, of the devices, or on the measurement of the difference between thermal conductivity in dry and in humid air [6–15]. Resistive sensors are low-cost and can be easily integrated in electronic circuits, making them ideal candidates for remote monitoring applications.

Among the resistive sensors, many sensing materials were investigated, such as metal oxides (Al₂O₃, Fe₂O₃, TiO₂, SiO₂, WO₃, ZnO, CuO and ZrO₂), perovskites (ZrTiO₄, LaFeO₃, BaTiO₃, LiNbO₃, SmCrO₃, etc.) and spinels (ZnWO₄, MnWO₄, NiWO₄, CoWO₄, MgCr₂O₄, ZnCr₂O₄, MgAl₂O₄, Fe₃O₄, etc.) [16,17], as well as carbon-based materials (e.g., carbon nanotubes, graphene oxides and biochar) [18–24]. Clay minerals with layered structures have also been also investigated, due to their high specific surface area and their capacity for ion exchange and the hydration process [25–27]. More recently, because of new applications such as the Internet of Things (IoT) and human-body monitoring, new sensors based on different materials such as paper [28], sulfides [29], sulfates [30], metal–organic frameworks (MOFs) [31] and other materials [32] have also been proposed.

Gas and humidity resistive sensors are often manufactured by screen-printing or spin-coating, or by brushing the sensing layer onto inert rigid or soft substrates, such as
ceramic or polymeric ones. However, in this case, only a limited volume of material is used for the detection of the target gas.

Additive manufacturing techniques allow the production of complex geometries. In this research, Digital Light Processing (DLP) was exploited for the direct preparation of active substrates able to support metallic electrodes and to act, at the same time, as sensing layers. Thus, preliminary printing tests were performed to produce planar substrates with thickness values that could allow them to survive the successive screen-printing process, while, at the same time, not being too thick. The obtained thickness value (1.07 mm, after firing) was a good compromise on this basis. In addition, typical tape-cast films are 100–300 µm thick [33], which would have required the pressing of several stacked green layers to obtain a substrate with the same thickness. In such a case, pore size and pore size distribution could be changed during this pressing step. Finally, uniaxially pressing pellets 1 mm thick was another alternative, even if handling them without any organic temporary binder could be challenging. For these reasons, stereolithography was chosen for the sensors’ manufacturing, with the aim of producing more-complex porous geometries in the future.

Mullite (3Al₂O₃·2SiO₂) is the only intermediate stable compound in the Al₂O₃-SiO₂ system, and it is known for its chemical inertness in harsh environments [34]. Thus, in this work, a commercial mullite powder was first characterized by X-ray diffraction (XRD) and laser granulometry. Then, a slurry based on a photocurable commercial resin with a dispersant, a sintering additive and the mullite powder was prepared, and planar substrates were printed by DLP. These substrates were partially sintered at two different temperatures in order to investigate the effects of residual porosity on humidity-sensing properties. Their electrical responses with respect to humidity and to interfering gases such as NH₃ (44 ppm in air), CH₄ (100 ppm in air), CO₂ (500 ppm in air) and NO₂ (2.5 ppm in air), as well as ethanol (68,800 ppm) and acetone (276,900 ppm), were studied for the first time.

2. Materials and Methods

2.1. Materials

A mullite commercial powder (SA 193 CR, from Baikowski SAS, Annecy, France) was used. Chemical characterization of the as-received powder was performed by XRD analysis using a Pananalytical X’Pert Pro instrument (Pananalytical, Eindhoven, The Netherlands) with CuKα radiation (0.154056 nm) in the 2θ range, 5–70°. Furthermore, the particle size distribution of the as-received powder was checked by laser granulometry (Mastersizer 3000, Malvern Panalytical, Malvern, Worcestershire, UK) in alcohol after 5 min sonication. A photocurable commercial resin (Admatec Europe BV, Alkmaar, The Netherlands) consisting of a liquid monomer resin system with a photo-initiator, diphenyl(2,4,6-trimethylbenzoyl)phosphine oxide and acrylates was used to prepare the slurry. A dispersant (Disperbyk-103, BYK Chemie, Wesel, Germany) was added to enhance the stability and increase the solid loading of the suspension.

2.2. Slurry Preparation

The slurry was manufactured by mechanically mixing the resin and the dispersant with the ceramic powder in order to obtain a solid loading of 69 wt%. After preliminary tests, 5.0 wt% dispersant was added (with respect to the dry powder) to the monomer, under mechanical stirring with a helix for 15 min. Then, mullite powder was gradually introduced into the mixture under continuous stirring, accurately avoiding the formation of agglomerates. Magnesium carbonate was also mixed as a sintering aid (1 wt% of equivalent MgO with respect to mullite) [35]. The total mixing process lasted 45 min. The obtained slurry was then milled in agate jars with agate spheres (d = 10 mm) for 6 h at 350 rpm in a planetary miller (Fritsch Pulverisette 5, Fritsch GmbH, Oberstein, Germany). The slurry was finally degassed for 30 min under vacuum by means of a rotative pump in order to allow the entrapped gas to leave the mixture and to obtain a homogeneous slurry. A rotational rheometer (Kinexus Pro+, Malvern Panalytical, Malvern, Worcestershire, UK)
equipped with stainless steel parallel plates (20 mm diameter, 1 mm gap between plates) was used to assess the rheology of the slurry at 25 °C. Shear rates in the range of 0.1–1000 s\(^{-1}\) were applied.

2.3. Digital Light Processing (DLP) and Post-Processing

Planar-shaped specimens were designed using the AutoCAD 2018 software and printed using a DLP-based stereolithographic printer (ADMAFLEX 130, ADMATEC Europe BV, Alkmaar, The Netherlands) operating with a 405 nm wavelength UV light. Curing depths and curing degrees of the UV-curable suspensions were investigated through several tests. Curing parameters are of paramount importance for the integrity and quality of the printed samples. Thus, first, the best compromise between high resolution, good adhesion, and the uniformity of each layer was investigated. The most reliable parameters were the following: layer thickness, exposure time, and LED power; these were equal to 30 µm, 1 s and 13.93 mW/cm\(^3\), respectively. During the printing process, a delay of 30 s before exposure was set to allow air bubbles to be expelled from the slurry. A 125 µm doctor blade was used. Slurries were exposed to the UV light in a chessboard configuration for different exposure times to determine the curing depth. The uncured slurry was then cleaned with paper and the thickness of the single layer was determined by means of a digital micrometer.

After printing, the samples were soaked in deionized water at approx. 40 °C for 6 h to enable researchers to easily remove with a brush the uncured slurry attached to the samples, promoting the removal of the contained water-soluble fraction. Indeed, the resin used (Blank resin C, water de-binding, ADMAFLEX, Alkmaar, The Netherlands) is specifically designed to avoid thermal de-binding defects during resin decomposition by creating a porous network (via water de-binding) through which decomposition gases can be removed without stressing the green samples. Then, the substrates were dried in an oven at 70 °C for 6 h. A thermal de-binding and sintering cycle (Carbolite 1800 electric furnace, Carbolite Gero GmbH, Neuhausen, Germany) (Figure 1) was set up. Specifically, the samples were slowly heated to 1000 °C to prevent cracking during resin decomposition and then were sintered up to 1400 °C (Sensor 1) and 1450 °C (Sensor 2) for 1 h, at a heating rate of 1 °C/min. These sintering temperatures were chosen based on preliminary tests: a too-high temperature guarantees higher mechanical properties but a lower porosity and sensor response. However, a minimum mechanical strength is needed because the substrates must withstand the screen-printing process for the metallic electrodes. The sintered density was determined according to the theoretical density (TD) of mullite (3.17 g/cm\(^3\)) and the microstructures of the films were observed by means of a field emission-scanning electron microscope (FE-SEM, Hitachi S3800, Tokyo, Japan).

2.4. Fabrication and Measurement of Gas Sensors

The platinum electrodes were screen-printed (Ferro 5545, King of Prussia, PA, USA; 2 successive prints) using an automatic machine with a 270-mesh steel screen. After drying overnight, the Pt ink was fired at 980 °C for 15 min to obtain a high-grade adhesion and optimize its electrical conductivity, as per the ink producer’s indications. The electrodes had widths of 400 µm and were spaced 450 µm from each other.
The sensor’s humidity response in the 0–100% relative humidity (RH) range was studied by means of a laboratory system at room temperature, under an airflow rate of 150 mL/min. The RH was increased progressively by steps, each one 15 min. In this system, the airflow (Siad, Turin, Italy, research grade) was split into two flows and controlled by means of mass flows (MF302, Teledyne Hastings, Hampton, VA, USA; mass flow controller: Teledyne 4000): the first one was kept anhydrous, whereas the second one passed through a water bubbler, generating a saturated humid flow. Then, both flows were combined.

A commercial probe for humidity and temperature measurements (Delta Ohm DO9406, Caselle di Selvazzano, PD, Italy; accuracy: ±0.1% in the 0–100% RH range from 50 to 250 °C) was used as reference for temperature, and RH values were determined inside the measurement chamber. During tests under a dynamic flow, the sensors’ impedance and phase were measured by an LCR meter (Hioki 3533-01, Ueda, Nagano, Japan). The alternating voltage was 2 V at a frequency of 1 kHz. Additionally, tests were also carried out for different gases, like NH₃ (44 ppm in air), CH₄ (100 ppm in air), CO₂ (500 ppm in air) and NO₂ (2.5 ppm in air), all under the same flow rate (all gases were provided by Siad, Turin, Italy and were research grade). Then, a bubbler with pure ethanol and acetone (Sigma Aldrich, Milan, Italy, reagent grades) was added and the response of the sensor was investigated at 23 °C. The gas concentrations (in %) were calculated according to the respective vapor pressures (52.3 mmHg for ethanol and 210.4 mmHg for acetone [36]) and Equation (1) [37]:

\[
g\text{gas concentration (\%)} = 100 \times \text{vapor pressure of the liquid in mmHg/760}
\]  

The response of the sensor (R) was calculated according to Equation (2)

\[
R = \frac{Z_0}{Z_g}
\]  

where \(Z_0\) and \(Z_g\) are the impedance values of the sensor under dry air and under humid air, respectively.

The sensitivity (S) of the sensor is the slope of the calibration curve, and it can be determined in accordance with Equation (3):

\[
S(Z) = \frac{\Delta Z}{\Delta RH}
\]  

The response time (the time required by a sensor to achieve 90% of the total impedance change in the presence of humid air) as well as the recovery time (the time needed for a
sensor to reach 90% of the total impedance variation during gas desorption) were calculated as well.

3. Results and Discussion

3.1. Powder Characterization

The as-received powder showed a multimodal distribution with a $\phi_{50}$ value close to ~29 $\mu$m (Table 1). After 5 min of sonication, the $\phi_{50}$ was equal to ~1.8 $\mu$m. Thus, sonication reduced the size of the coarser fractions. It can be concluded that the as-received powder presented soft agglomeration.

<table>
<thead>
<tr>
<th></th>
<th>$\phi_{10}$ ($\mu$m)</th>
<th>$\phi_{50}$ ($\mu$m)</th>
<th>$\phi_{90}$ ($\mu$m)</th>
</tr>
</thead>
<tbody>
<tr>
<td>As received</td>
<td>0.90</td>
<td>28.70</td>
<td>106.00</td>
</tr>
<tr>
<td>5 min sonication</td>
<td>0.58</td>
<td>1.76</td>
<td>4.36</td>
</tr>
</tbody>
</table>

The XRD pattern of the as-received mullite is reported in Figure 2; the pattern corresponds mainly to mullite (JCPDS card no 15-0776). Cristobalite ($\text{SiO}_2$, JCPD file 96-900-8230) and aluminum oxide ($\text{Al}_2\text{O}_3$, JCPFD files 96-900-7499 and 00-035-0121, for the hexagonal and the monoclinic phase, respectively) were also detected.

![XRD pattern of as-received mullite](image)

Figure 2. XRD patterns of the as-received mullite (m: mullite, c: cristobalite, A: aluminum oxide, a: corundum).

3.2. Sensor-Based Microstructural Characterization

The different sintering temperatures (1400 or 1450 °C, for 1h) produced a slight difference in substrate porosity: in fact, Sensor 1 samples were characterized by a porosity of 19% (determined according to the Archimedes method), and Sensor 2, of 17%. Before sintering, the average dimensions of the substrates were: $23.12 \times 15.48 \times 1.19 \text{ mm}^3$. After sintering, the average dimensions of the plates were: $21.56 \times 14.4 \times 1.07 \text{ mm}^3$ for Sensor 1 and $20.15 \times 13.46 \times 1.07 \text{ mm}^3$ for Sensor 2. Volume shrinkages of 20% for Sensor 1 and 32% for Sensor 2 were then calculated after sintering. The substrates were to be handled with care because of the rather low sintering temperature (with the same mullite powder and 1 wt% addition of MgO, full density can be reached after sintering at 1550 °C for 3 h [35].
while the sensors were heat-treated at 1400 °C and 1450 °C for 1 h only). However, they were able to survive the screen-printing step, in which the steel mesh comes into contact with the sample and the squeegee forces the ink to pass through the former. When flat surfaces were obtained, no breaking of samples was observed. An image of the printed sensor with screen-printed electrodes is reported in Figure 3.

![Figure 3. Optical micrograph of the 3D printed mullite sensor with screen-printed interdigitated electrodes, sintered at 1400 °C for 60 min.](image)

The FE-SEM micrographs of the 3D printed mullite sintered at 1400 °C and 1450 °C are presented in Figure 4. The microstructures appear porous, and the lower annealing temperature (1400 °C) led to the creation of a spongier structure (Figure 4a,c), in comparison with the one obtained at a higher temperature (1450 °C) (Figure 4b,d), which was as expected, considering the respective densities of the sensors. Sensor 1 looks like a consolidated powder at the very beginning of the sintering process (Figure 4c), while on sensor 2 a coarsening of the grain powders is already visible (Figure 4d).

![Figure 4. Cont.](image)
3.3. Humidity-Sensing Properties

The sensor response, in terms of impedance and the phase variation of Sensors 1 and 2 are plotted in Figures 5 and 6. When in contact with humidity, the impedance value dropped from 155 MΩ under dry air to 480 kΩ under 85 RH% for Sensor 1, and from 115 MΩ under dry air to 410 kΩ for Sensor 2 (Figures 5a and 6a). The higher porosity of Sensor 1 can explain the higher initial (under dry air) impedance value.

Initially, at a low humidity level, the impedance value slightly changes, while above 19 RH%, the impedance of the sensor sharply drops down with the increase in humidity level (Figures 5a and 6a). At the same time, the phase increased continuously, from approximately −90° under dry air to approximately −3° under 85 RH% (Figures 5b and 6b), as already observed with humidity sensors based on rice husk ash [38].

Figure 4. FE-SEM micrographs of the 3D printed mullite sintered at 1400 °C (a,c) and 1450 °C (b,d) for 1 h.

Figure 5. Response as a function of relative humidity value for mullite Sensor 1, sintered at 1400 °C: (a) impedance variation and (b) phase variation.
Comparing the sensors’ performances under 85% humidity (see Figure 7), Sensor 1 shows 13% higher sensor response as compared to Sensor 2 (322.9 and 280.5, respectively). The sensor also had negligible hysteresis within the measurement error.

Figure 7. Responses of Sensors 1 and 2 at different RH values (in the range 26–85% RH).

Table 2 summarizes the sensors’ response and response/recovery times at different humidity levels associated with mullite Sensors 1 and 2. The response and recovery times of Sensor 1 (91 and 167 s, respectively) are longer than those of Sensor 2 (64 and 119 s, respectively), probably because of a higher surface area, due to the lower sintering temperature.
Table 2. The sensors’ response and response/recovery times at different humidity levels associated with mullite Sensors 1 and 2.

<table>
<thead>
<tr>
<th>Humidity</th>
<th>Sensor Response ( R = \frac{Z_o}{Z_g} )</th>
<th>Response Time, s</th>
<th>Recovery Time, s</th>
</tr>
</thead>
<tbody>
<tr>
<td>19%</td>
<td>1.0</td>
<td>406</td>
<td>67</td>
</tr>
<tr>
<td>26%</td>
<td>1.1</td>
<td>372</td>
<td>35</td>
</tr>
<tr>
<td>33%</td>
<td>1.5</td>
<td>406</td>
<td>67</td>
</tr>
<tr>
<td>40%</td>
<td>3.0</td>
<td>372</td>
<td>35</td>
</tr>
<tr>
<td>47%</td>
<td>7.2</td>
<td>255</td>
<td>71</td>
</tr>
<tr>
<td>56%</td>
<td>20.2</td>
<td>174</td>
<td>87</td>
</tr>
<tr>
<td>65%</td>
<td>48.1</td>
<td>122</td>
<td>113</td>
</tr>
<tr>
<td>74%</td>
<td>103.3</td>
<td>97</td>
<td>122</td>
</tr>
<tr>
<td>82%</td>
<td>238.5</td>
<td>70</td>
<td>149</td>
</tr>
<tr>
<td>85%</td>
<td>322.9</td>
<td>64</td>
<td>167</td>
</tr>
</tbody>
</table>

In Figure 8, three consecutive measurements on mullite Sensors 1 and 2 under 85% RH are displayed. Both sensors show an excellent repeatability.

Figure 8. Repeatability measurements of mullite Sensors 1 and 2 under 85% RH: (a) impedance variation and (b) phase variation.

The calibration curves of the mullite sensors are illustrated in Figure 9. The slopes (sensor sensitivity) are 0.0434 RH\(^{-1}\) and 0.0446 RH\(^{-1}\) for Sensor 1 and Sensor 2, respectively, when \( \log(R) \) is plotted as a function of the relative humidity value.

The humidity-sensing mechanism of the sintered mullite sensor is based on the protonic conduction on the surface. When exposed to the humidity of the environment, the impedance changes in the mullite sensors depend on the number of adsorbed water molecules. The RH level directly dictates the number of adsorbed water molecules on the mullite’s surface. As the RH level increases, more water molecules are adsorbed, and this leads to a further decrease in the resistance value.

In Ref. [39], nanostructured ZnO, ZnO-TiO\(_2\) humidity sensors were investigated. At the first stage of adsorption process, the negatively charged oxygen species were electrostatically attached to the positively charged metallic ions of the sensing material and formed a hydroxide layer. Thereby, the grain surfaces adjacent to the pores are covered by a chemisorbed monolayer. With the increase in relative humidity, the first physisorbed layer forms when single water molecules bind to two surface hydroxyls. A hydronium...
group $\text{H}_3\text{O}^+$ is then formed through those molecules in the second layer that are singly bound to the underlying layer by hydrogen bonds.

A proton is thereby released to neighboring water molecules, which accept it while releasing another proton, and so on (this is the so-called Grothuss chain-reaction mechanism) [17]. This proton is free to move along the water molecules and thus governs the sensor conductivity. At higher humidity levels, liquid water can also condense in pores, and electrolytic conduction can occur at the same time [16].

At low humidity levels, during the progressive formation of the first physisorbed layer of water molecules, the equivalent electrical circuit of oxidic humidity sensors is a parallel RC circuit [40,41]. The higher the degree of physical adsorption, the emerging ionic conduction and successive capillary water condensation, previously described, lead to a stronger decrease of the impedance of the film, as observed and supported by the phase change from almost $-90^\circ$ to about $-3^\circ$. For these higher RH values, the equivalent circuit can be drawn by a number of (typically two) series-connected parallel RC circuits [40,41]. Then, a sweep in frequency (from 22 kHz to 100 kHz) was performed under 65% RH (Figure S7). The resistance and the capacitance of the two elements in parallel in the equivalent circuit were calculated and were equal to 60 MOhm and $4.94 \times 10^{-14}$ F, respectively, at 53.7 kHz (at the apex of the Nyquist plot of the impedance diagram).

Tests were also performed at room temperature for ammonia (44 ppm), methane (100 ppm) and carbon dioxide (500 ppm), and nitrogenous oxide (2.5 ppm), as well as ethanol (68,800 ppm) and acetone (276,900 ppm) (Figures S1–S6, Supplementary Information). No interference towards the tested gases was observed, so the mullite sensors also exhibited a good selectivity with respect to humidity at room temperature.

Table 3 presents the results illustrated in this paper, and the recent literature data (of the last 5 years) on resistive sensors based on ceramic oxides; the obtained performances are rather promising. The response and recovery times can probably be further improved by printing more complex geometries to fully exploit the potentialities of DLP, as in Ref. [42].
Table 3. Comparison of mullite 3D printed sensor’s performance with those in described in recent literature data on resistive sensors based on ceramic oxides.

<table>
<thead>
<tr>
<th>Material</th>
<th>Sensor Response, $R = Z_o/Z_g$</th>
<th>Response Time, s</th>
<th>Recovery Time, s</th>
<th>Reference</th>
</tr>
</thead>
<tbody>
<tr>
<td>Pt decorated MoS$_2$ nanoflakes</td>
<td>~4000 at 85% RH</td>
<td>92</td>
<td>154</td>
<td>[29]</td>
</tr>
<tr>
<td>ZnO/MoS$_2$</td>
<td>~301 at 85% RH</td>
<td>138</td>
<td>166</td>
<td>[43]</td>
</tr>
<tr>
<td>Porous aluminum-doped ZnO</td>
<td>733% at 90% RH</td>
<td>~238</td>
<td>~202</td>
<td>[44]</td>
</tr>
<tr>
<td>Copper ferrite-yttrium oxide nanocomposite</td>
<td>4895 at 97% RH</td>
<td>9</td>
<td>23</td>
<td>[45]</td>
</tr>
<tr>
<td>Titanium dioxide nanotubes</td>
<td>58.5 at 90% RH</td>
<td>NA</td>
<td>NA</td>
<td>[46]</td>
</tr>
<tr>
<td>Cs$_3$Bi$_2$Br$_9$ perovskite</td>
<td>987 at 90% RH</td>
<td>5.56</td>
<td>6.24</td>
<td>[47]</td>
</tr>
<tr>
<td>SrTiO$_3$ nanoparticles</td>
<td>1.12 at 85% RH</td>
<td>100</td>
<td>300</td>
<td>[48]</td>
</tr>
<tr>
<td>GdAlO$_3$</td>
<td>8000 at 97% RH</td>
<td>45</td>
<td>60</td>
<td>[49]</td>
</tr>
<tr>
<td>Mn$<em>{0.5}$Zn$</em>{0.5}$Dy$_x$Ho$<em>y$Fe$</em>{2-x}$O$_4$ (x = 0.005 to 0.03) nanoparticles</td>
<td>99% at 97% RH</td>
<td>90</td>
<td>18</td>
<td>[50]</td>
</tr>
<tr>
<td>Al–Sr and Al–Cd nano-materials</td>
<td>2.87 at 95% RH</td>
<td>60</td>
<td>29</td>
<td>[51]</td>
</tr>
<tr>
<td>Reduced graphene oxide/zinc oxide nanostructured powder</td>
<td>172 at 90% RH</td>
<td>NA</td>
<td>NA</td>
<td>[52]</td>
</tr>
<tr>
<td>Zn$<em>x$Al$</em>{2-x}$O$_4$(TiO$_2$)$_x$</td>
<td>265 at 97% RH</td>
<td>195</td>
<td>28</td>
<td>[53]</td>
</tr>
<tr>
<td>Dy$_2$O$_3$ nanorods</td>
<td>15 at 97% RH</td>
<td>2</td>
<td>5</td>
<td>[54]</td>
</tr>
<tr>
<td>Ta-doped TiO$_2$/reduced graphene oxide</td>
<td>232% at 90% RH</td>
<td>4.2</td>
<td>3.3</td>
<td>[55]</td>
</tr>
<tr>
<td>Sr-doped LaFeO$_3$ nanofibers</td>
<td>60,597 at 90% RH</td>
<td>NA</td>
<td>NA</td>
<td>[56]</td>
</tr>
<tr>
<td>N-doped graphene oxide-WO$_3$</td>
<td>3427 at 98% RH</td>
<td>24</td>
<td>53</td>
<td>[57]</td>
</tr>
<tr>
<td>Nanosized $\alpha$-Fe$_2$O$_3$ nanoparticles</td>
<td>48,569 at 95% RH</td>
<td>9</td>
<td>4</td>
<td>[58]</td>
</tr>
<tr>
<td>(CaSO$_4$·2H$<em>2$O)$</em>{0.975}$·(CuSO$_4$·5H$<em>2$O)$</em>{0.025}$</td>
<td>6.75 at 90% RH</td>
<td>5</td>
<td>3</td>
<td>[30]</td>
</tr>
<tr>
<td>SnO$_2$ thin film</td>
<td>3.1 at 95% RH</td>
<td>84</td>
<td>576</td>
<td>[59]</td>
</tr>
<tr>
<td>Porous SnO$_2$/MCM-48</td>
<td>$10^5$ at 98% RH</td>
<td>9</td>
<td>12</td>
<td>[60]</td>
</tr>
<tr>
<td>2D MoO$_3$</td>
<td>4024 at 75% RH</td>
<td>8</td>
<td>40</td>
<td>[61]</td>
</tr>
<tr>
<td>Perovskite CaPbBr$_3$-Fe quantum dots</td>
<td>1.1 at 70% RH</td>
<td>38</td>
<td>38</td>
<td>[62]</td>
</tr>
<tr>
<td>Mullite</td>
<td>322.9 at 85% RH</td>
<td>91</td>
<td>167</td>
<td>This work</td>
</tr>
</tbody>
</table>

4. Conclusions

In this work, 3D printed mullite substrates with two different porosities were fabricated to evaluate the effects of porosity and surface area on humidity sensitivity: one was sintered at 1400 °C, and the other one at 1450 °C. As a result of this difference, the resultant porosity of the samples affected the sensitivity of the sensors; this effect can be controlled by varying the heat treatment’s temperature.

At room temperature, the impedance value dropped downward, from 155 MΩ under dry air to 480 kΩ under 85 RH% for Sensor 1, and from 115 MΩ under dry air to 410 kΩ for Sensor 2. At low humidity levels, the impedance change is small, while above 19 RH%, the impedance of the sensor decreases sharply with the increase in humidity content. When the RH level changed from 0% to 85%, the response times were equal to 91 s for Sensor 1 and 64 s for Sensor 2, whereas the recovery times were equal to 167 s for Sensor 1 and 119 s for Sensor 2. In addition, tests carried out for ammonia (44 ppm), methane (100 ppm), carbon dioxide (500 ppm), and nitrogenous oxide (2.5 ppm), as well as ethanol (68,800 ppm) and acetone (276,900 ppm) showed no interference.

This work shows that resistive ceramic humidity sensors can be easily produced by 3D printing techniques and that their use in harsh environments (in corrosive atmospheres, for example) can be envisaged.
**Supplementary Materials:** The following supporting information can be downloaded at: [https://www.mdpi.com/article/10.3390/ceramics7020053/s1](https://www.mdpi.com/article/10.3390/ceramics7020053/s1), Figure S1: Response of the Sensor S2 to 500 ppm CO₂ in air, Figure S2: Response of the Sensor S2 to 100 ppm CH₄ in air, Figure S3: Response of the Sensor S2 to 2.5 ppm NO₂ in air, Figure S4: Response of the Sensor S2 to 44 ppm NH₃ in air, Figure S5: Response of the Sensor S2 to 276,900 ppm (27.69%) acetone in air, Figure S6: Response of the Sensor S2 to 68,800 ppm (6.88%) ethanol in air, Figure S7: Impedance diagram for the sensor S2 under 65% RH.

**Author Contributions:** Conceptualization, J.-M.T. and P.P.; methodology, Y.M., B.C. and A.B.; software, Y.M. and A.B.; validation, J.-M.T., P.P. and B.C.; formal analysis, J.-M.T.; investigation, Y.M. and A.B.; data curation, Y.M. and A.B.; writing—original draft preparation, Y.M.; writing—review and editing, all authors; supervision, J.-M.T. All authors have read and agreed to the published version of the manuscript.

**Funding:** This research received no external funding.

**Institutional Review Board Statement:** Not applicable.

**Informed Consent Statement:** Not applicable.

**Data Availability Statement:** The data presented in this study are available on request from the corresponding author.

**Acknowledgments:** The Authors greatly acknowledge the Interdepartmental laboratory SISCON (Safety of Infrastructures and Constructions) from Politecnico di Torino, for the use of the rheometer. The Authors also acknowledge Politecnico di Torino, for the grant to carry out research activity “Development of new materials and devices for the detection of gaseous pollutants”.

**Conflicts of Interest:** The authors declare no conflicts of interest.

**References**

Ceramics 2024, 7


30. Nikulicheva, T.B.; Zakhvalinskii, V.S.; Pilyuk, E.A.; Nikulin, I.S.; Vyazmin, V.V.; Mishunin, M.V. New humidity sensor material (CaSO4·2H2O)0.975-(CuSO4·5H2O)0.025. Materialia 2023, 27, 101662. [CrossRef]


42. Qi, G.; Weng, Y.; Chen, J. Preparation of porous SnO2-based ceramics with lattice structure by DLP. Ceram. Int. 2022, 48, 14568–14577. [CrossRef]


53. Dubey, R.S.; Srilali, S.; Ravikiran, Y.T.; Babu, G.S.; Katta, K.V. Synthesis and characterization of Zn$_{x-1}$Al$_2$O$_4$(TiO$_2$)$_x$ nanocomposite ceramics and their humidity sensing properties. *J. Mater. Sci.* **2022**, *57*, 2636–2649. [CrossRef]


Disclaimer/Publisher’s Note: The statements, opinions and data contained in all publications are solely those of the individual author(s) and contributor(s) and not of MDPI and/or the editor(s). MDPI and/or the editor(s) disclaim responsibility for any injury to people or property resulting from any ideas, methods, instructions or products referred to in the content.